

September 2009

H11AV1M, H11AV1AM, H11AV2M, H11AV2AM Phototransistor Optocouplers

Features

- H11AV1M and H11AV2M feature 0.3" input-output lead spacing
- H11AV1AM and H11AV2AM feature 0.4" input-output lead spacing
- UL recognized (File #E90700, Vol. 2)
- VDE recognized (File #102497)
- Add option V (e.g., H11AV1AVM)

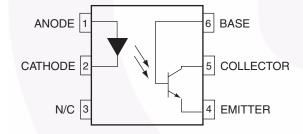
Applications

- Power supply regulators
- Digital logic inputs
- Microprocessor inputs

Description

The general purpose optocouplers consist of a gallium arsenide infrared emitting diode driving a silicon phototransistor in a 6-pin dual in-line white package.

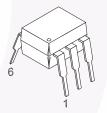
Schematic



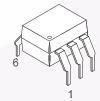
Package Outlines



H11AV1SM, H11AV2SM



H11AV1M, H11AV2M



H11AV1AM, H11AV2AM

Absolute Maximum Ratings (T_A = 25°C unless otherwise specified.)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Value	Units
TOTAL DEVI	CE	1	
T _{STG}	Storage Temperature	-40 to +150	°C
T _{OPR}	Operating Temperature	-40 to +100	°C
T _{SOL}	Wave Solder Temperature (see page 8 for reflow solder profiles)	260 for 10 sec	°C
P_{D}	Total Device Power Dissipation @ T _A = 25°C	250	mW
	Derate above 25°C	2.94	mW/°C
EMITTER			
I _F	DC / Average Forward Input Current	60	mA
V _R	Reverse Input Voltage	6	V
P _D	LED Power Dissipation @ T _A = 25°C	120	mW
	Derate above 25°C	1.41	mW/°C
DETECTOR			
V _{CEO}	Collector-Emitter Voltage	70	V
V _{CBO}	Collector-Base Voltage	70	V
V _{ECO}	Emitter-Collector Voltage	7	V
P _D	Detector Power Dissipation @ T _A = 25°C	150	mW
	Derate above 25°C	1.76	mW/°C

Electrical Characteristics (T_A = 25°C unless otherwise specified.)

Individual Component Characteristics

Symbol	Parameter	Test Conditions	Min.	Тур.*	Max.	Unit
EMITTER		•	•			
V _F	Input Forward Voltage (I _F = 10mA)	T _A = 25°C	0.8	1.18	1.5	V
		T _A = -55°C	0.9	1.28	1.7	
		T _A = 100°C	0.7	1.05	1.4	
I _R	Reverse Leakage Current	V _R = 6.0V			10	μΑ
DETECTOR						-
BV _{CEO}	Collector-Emitter Breakdown Voltage	$I_C = 1.0 \text{mA}, I_F = 0$	70	100		V
BV _{CBO}	Collector-Base Breakdown Voltage	$I_C = 100 \mu A, I_F = 0$	70	120		V
BV _{ECO}	Emitter-Collector Breakdown Voltage	$I_E = 100 \mu A, I_F = 0$	7	10		V
I _{CEO}	Collector-Emitter Dark Current	$V_{CE} = 10V, I_{F} = 0$		1	50	nA
I _{CBO}	Collector-Base Dark Current	V _{CB} = 10V		0.5		nA
C _{CE}	Capacitance	$V_{CE} = 0V, f = 1MHz$		8		pF

Transfer Characteristics

Symbol	Parameter	Test Conditions	Device	Min.	Тур.*	Max.	Unit	
DC CHARA	DC CHARACTERISTIC							
CTR	Current Transfer Ratio, Collector to Emitter	I _F = 10mA, V _{CE} = 10V	H11AV1M H11AV1AM	100		300	%	
			H11AV2M H11AV2AM	50				
V _{CE (SAT)}	Collector-Emitter Saturation Voltage	I _C = 2mA, I _F = 20mA	All			0.4	V	
AC CHARA	AC CHARACTERISTIC							
T _{ON}	Non-Saturated Turn-on Time	$I_C = 2mA, V_{CC} = 10V,$ $R_L = 100\Omega$ (Fig. 11)	All			15	μs	
T _{ON}	Non Saturated Turn-off Time	$I_C = 2mA, V_{CC} = 10V,$ $R_L = 100\Omega$ (Fig. 11)	All			15	μs	

Isolation Characteristics

Symbol	Parameters	Test Conditions	Min.	Тур.*	Max.	Units
V _{ISO}	Input-Output Isolation Voltage	f = 60Hz, t = 1 sec.	7500			V _{AC(pk)}
C _{ISO}	Isolation Capacitance	$V_{I-O} = 0V, f = 1MHz$		0.2	2	pF
R _{ISO}	Isolation Resistance	V _{I-O} = 500 VDC	10 ¹¹			Ω

^{*}Typical values at T_A = 25°C

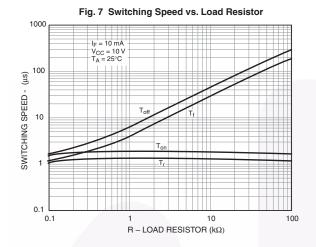
Safety and Insulation Ratings

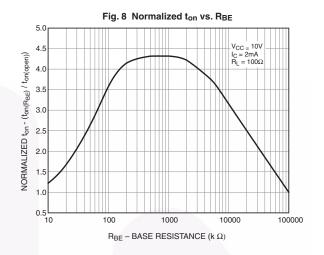
As per IEC 60747-5-2, this optocoupler is suitable for "safe electrical insulation" only within the safety limit data. Compliance with the safety ratings shall be ensured by means of protective circuits.

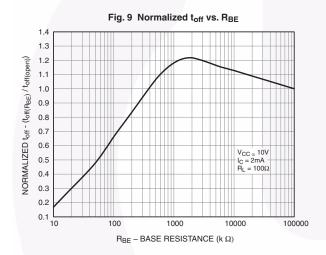
Symbol	Parameter	Min.	Тур.	Max.	Unit
	Installation Classifications per DIN VDE 0110/1.89 Table 1				
	For Rated Main Voltage < 150Vrms		I-IV		
	For Rated Main voltage < 300Vrms		I-IV		
	Climatic Classification		55/100/21		
	Pollution Degree (DIN VDE 0110/1.89)		2		
CTI	Comparative Tracking Index	175			
V _{PR}	Input to Output Test Voltage, Method b, V _{IORM} x 1.875 = V _{PR} , 100% Production Test with tm = 1 sec, Partial Discharge < 5pC	1594			V _{peak}
	Input to Output Test Voltage, Method a, V _{IORM} x 1.5 = V _{PR} , Type and Sample Test with tm = 60 sec, Partial Discharge < 5pC	1275			V _{peak}
V _{IORM}	Max. Working Insulation Voltage	850			V _{peak}
V_{IOTM}	Highest Allowable Over Voltage	6000			V _{peak}
	External Creepage	7			mm
	External Clearance	7			mm
	Insulation Thickness	0.5			mm
RIO	Insulation Resistance at Ts, V _{IO} = 500V	10 ⁹			Ω

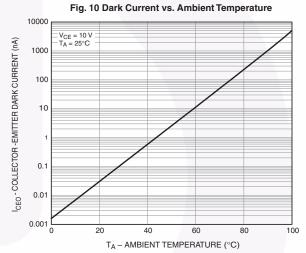
Typical Performance Curves Fig. 1 LED Forward Voltage vs. Forward Current Fig. 2 Normalized CTR vs. Forward Current 1.8 1.6 Normalized to I_F = 10mA 1.7 1.4 FORWARD VOLTAGE (V) 1.2 1.6 NORMALIZED CTR 1.5 1.0 1.4 0.8 1.3 0.6 1.2 0.4 1.1 0.2 1.0 0.0 100 0 2 10 12 8 IF - LED FORWARD CURRENT (mA) - FORWARD CURRENT (mA) Fig. 4 CTR vs. RBE (Unsaturated) Fig. 3 Normalized CTR vs. Ambient Temperature 1.4 1.0 NORMALIZED CTR (CTR_{RBE} / CTR_{RBE}(OPEN)) 0.9 I_F = 20mA 1.2 0.8 I= = 5mA 0.7 NORMALIZED CTR 1.0 0.6 $I_F = 10mA$ 0.5 0.8 0.4 0.3 0.6 0.2 V_{CE} = 5.0V 0.1 0.4 Normalized to 0.0 $I_F = 10\text{mA}$ $T_A = 25^{\circ}\text{C}$ 0.2 1000 10 100 -60 -40 20 60 80 100 R_{BE} – BASE RESISTANCE (k Ω) TA - AMBIENT TEMPERATURE (°C) Fig. 6 Collector-Emitter Saturation Voltage vs Collector Current Fig. 5 CTR vs. RBE (Saturated) VCE (SAT) - COLLECTOR-EMITTER SATURATION VOLTAGE (V) 1.0 NORMALIZED CTR (CTR_{RBE} / CTR_{RBE}(OPEN)) 0.9 T_A = 25°C 0.8 10 0.7 0.6 1 0.5 I= = 10mA 0.4 0.1 0.2 0.01 0.1 10 100 1000 0.001 R_{BE} - BASE RESISTANCE ($k\Omega$) 0.01 0.1 10 I_C - COLLECTOR CURRENT (mA)

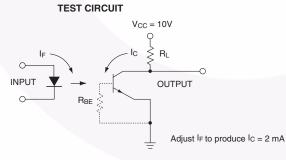
Typical Performance Curves (Continued)











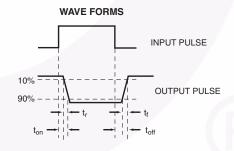
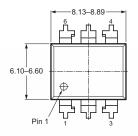
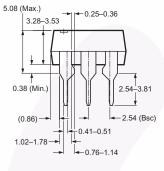


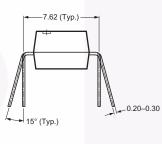
Figure 11. Switching Time Test Circuit and Waveforms

Package Dimensions

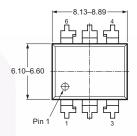
Through Hole

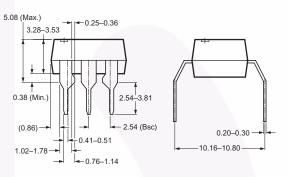




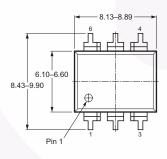


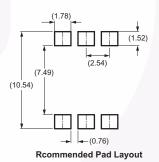
0.4" Lead Spacing

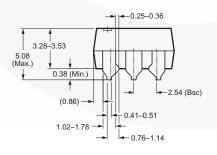


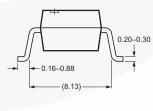


Surface Mount







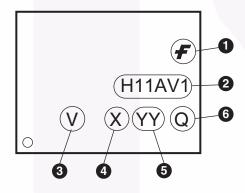


Note: All dimensions in mm.

Ordering Information

Option	Order Entry Identifier (Example)	Description
No option	H11AV1M	Standard Through Hole Device
S	H11AV1SM	Surface Mount Lead Bend
SR2	H11AV1SR2M	Surface Mount; Tape and Reel
Т	H11AV1TM	0.4" Lead Spacing
V	H11AV1VM	VDE 0884
TV	H11AV1TVM	VDE 0884, 0.4" Lead Spacing
SV	H11AV1SVM	VDE 0884, Surface Mount
SR2V	H11AV1SR2VM	VDE 0884, Surface Mount, Tape and Reel

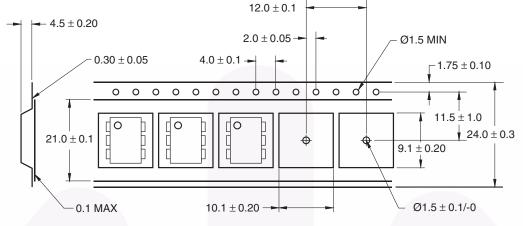
Marking Information



Definitions					
1	Fairchild logo				
2	Device number				
3	VDE mark (Note: Only appears on parts ordered with VDE option – See order entry table)				
4	One digit year code, e.g., '3'				
5	Two digit work week ranging from '01' to '53'				
6	Assembly package code				

*Note – Parts that do not have the 'V' option (see definition 3 above) that are marked with date code '325' or earlier are marked in portrait format.

Tape Dimensions

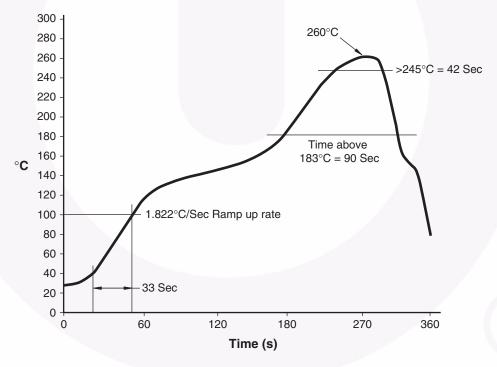


User Direction of Feed ----

Note:

All dimensions are in millimeters.

Reflow Soldering Profile







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Definition of Terms

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